

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5317687

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUPING REN	12/21/2018
HAIGOU HUANG	12/21/2018
RAVI PRAKASH SRIVASTAVA	01/09/2019
ZHIGUO SUN	12/21/2018
QIANG FANG	12/21/2018
CHENG XU	12/21/2018
GUOXIANG NING	12/21/2018
RECEIVING PARTY DATA	
Name:	GLOBALFOUNDRIES INC.
Street Address:	P.O.BOX 309, UGLAND HOUSE
City:	GRAND CAYMAN
State/Country:	CAYMAN ISLANDS
Postal Code:	KY1-1104
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16244071
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	518-305-9166
Email:	ippg.prosecution@globalfoundries.com
Correspondent Name:	GLOBALFOUNDRIES, INC.
Address Line 1:	SANTA CLARA GATEWAY
Address Line 2:	2600 GREAT AMERICA WAY
Address Line 4:	SANTA CLARA, CALIFORNIA 95054
ATTORNEY DOCKET NUMBER:	KALB102-US-NP
NAME OF SUBMITTER:	HUNTER AUYANG
SIGNATURE:	/Hunter Auyang/
DATE SIGNED:	01/09/2019

PATENT

Total Attachments: 7

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COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	CHAMFERLESS INTERCONNECT VIAS OF SEMICONDUCTOR DEVICES
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DECLARATION

As the below named inventor, I hereby declare that:

This declaration is directed to: The attached application, or
 United States application or PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

ASSIGNMENT

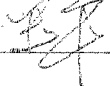
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Inc. having a business address of PO Box 309, Uglund House, Grand Cayman KY1-1104 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.

LEGAL NAME OF INVENTOR

Inventor: REN, YUPING

Date: Dec/21/2018

Signature: 

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.

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LEGAL NAME OF INVENTOR

Inventor: HUANG, HAIGOU

Date: Dec - 21 - 2018

Signature: 

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**Title of
Invention**

CHAMFERLESS INTERCONNECT VIAS OF SEMICONDUCTOR DEVICES

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LEGAL NAME OF INVENTOR

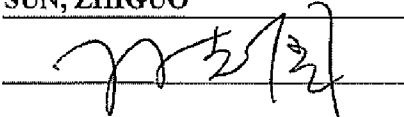
Inventor: SRIVASTAVA, RAVI PRAKASH

Date : 01/09/2019

Signature: 

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LEGAL NAME OF INVENTOR	
Inventor:	<u>SUN, ZHIGUO</u>
Signature:	
Date:	<u>12/21/2018</u>
<p>Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.</p>	

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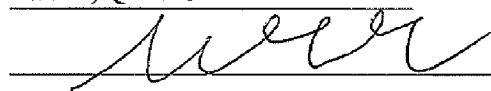
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LEGAL NAME OF INVENTOR

Inventor: FANG, QIANG

Date: 12-21-2018

Signature: _____



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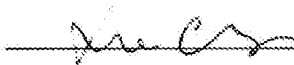
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LEGAL NAME OF INVENTOR

Inventor: XU, CHENG

Date: Dec. 21, 2018

Signature: 

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LEGAL NAME OF INVENTOR

Inventor: NING, GUOXIANG

Date: Dec. 21 2018

Signature: Guoxiang

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PATENT